

Transient Voltage Suppressors for ESD Protection

General Description

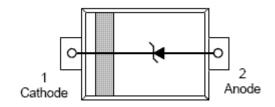
The PESD5Z3.3-12V Series is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium.

Applications

- Cellular phones
- Portable devices
- Digital cameras
- Power supplies

Features

- Small Body Outline Dimensions
- Low Body Height
- Stand-off Voltage: 2.5 V 12 V
- Peak Power up to 200 Watts @ 8 x 20 _s Pulse
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- IEC61000-4-2 Level 4 ESD Protection
- IEC61000–4–4 Level 4 EFT Protection
- We declare that the material of product compliance with RoHS reqirements.
- S-Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.



SOD-523

ORDERING INFORMATION

Device	Package	Shipping
PESD5Z2.5-12V	SOD-523	3000/Tape & Reel

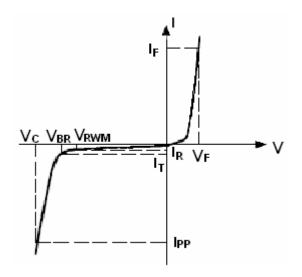
Absolute Ratings (T_{amb}=25°C)

Symbol	Parameter	Value	Units
P_{PP}	Peak Pulse Power (t _p = 8/20μs)	200	W
TL	Maximum lead temperature for soldering during 10s	260	°C
T _{stg}	Storage Temperature Range	-55 to +150	°C
T _{op}	Operating Temperature Range	-40 to +125	°C
Tj	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD) air discharge contact discharge	±15 ±8	KV
	IEC61000-4-4 (EFT)	40	Α
	ESD Voltage Per Human Body Model	16	KV



Electrical Parameter

Symbol	Parameter			
I_{PP}	Maximum Reverse Peak Pulse Current			
V _C	Clamping Voltage @ I _{PP}			
V_{RWM}	Working Peak Reverse Voltage			
I _R	Maximum Reverse Leakage Current @ V _{RWM}			
I _T	Test Current			
V_{BR}	Breakdown Voltage @ I _T			
I _F	Forward Current			
V _F	Forward Voltage @ I _F			



Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.VF = 0.9V at IF = 10mA

Туре	VRWM (V)	Ir(∝A)@ Vrwm	Vbr(V)@It		lτ	V (V)@ C Max Ipp*	IPP(A)*	C(PF)
	Max.	Max.	Min.	Max.	mA	Max.	Max.	Тур.
PESD5Z2. 5	2.5	6.0	4.0	5.0	1.0	9.8	7.2	96
PESD5Z3. 3	3.3	1.0	5.6	6.0	1.0	13.5	7.4	70
PESD5Z5. 0	5.0	1.0	6.2	6.9	1.0	17.2	6.2	53
PESD5Z6. 0	6.0	1.0	6.8	7.4	1.0	18.8	5.8	47
PESD5Z7. 0	7.0	1.0	7.5	8.8	1.0	20.5	5.8	43
PESD5Z12	12.0	1.0	13.5	15.5	1.0	23.6	6.3	37

注: 1. V≤0.9V@I =10mA适用于表中所有产品; 2. *8×20µs脉冲波。



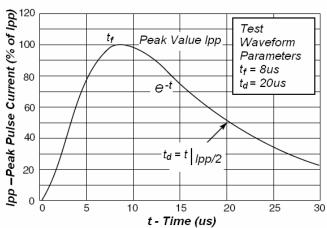


Fig1. Pulse Waveform

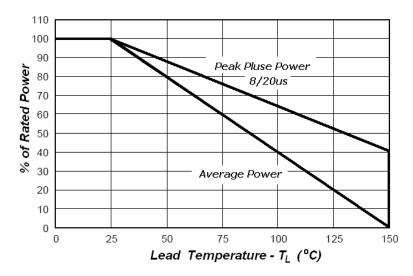


Fig3.Power Derating

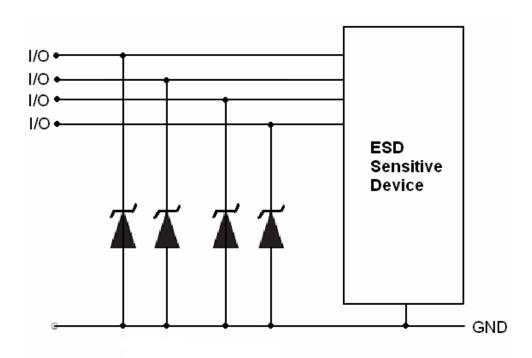
Application Note

Electrostatic discharge (ESD) is a major cause of failure in electronic systems. Transient Voltage Suppressors (TVS) are an ideal choice for ESD protection. They are capable of clamping the incoming transient to a low enough level such that damage to the protected semiconductor is prevented.

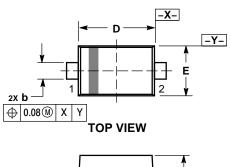
Surface mount TVS offer the best choice for minimal lead inductance. They serve as parallel protection elements, connected between the signal line to ground. As the transient rises above the operating voltage of the device, the TVS becomes a low impedance path diverting the transient current to ground. The PESD5Z2.5 is the ideal board evel protection of ESD sensitive semiconductor components.

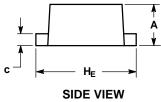
The tiny SOD523 package allows design flexibility in the design of high density boards where the space saving is at a premium. This enables to shorten the routing and contributes to hardening againt ESD.



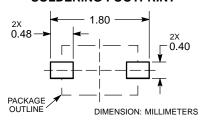


SC-79/SOD-523





RECOMMENDED SOLDERING FOOTPRINT*



NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
 MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
 BASE MATERIAL.
 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS					
DIM	MIN	NOM	MAX			
Α	0.50	0.60	0.70			
b	0.25	0.30	0.35			
С	0.07	0.14	0.20			
D	1.10	1.20	1.30			
E	0.70	0.80	0.90			
HE	1.50	1.60	1.70			
L	0.30 REF					
L2	0.15	0.20	0.25			